Search Notes

Application/Control No.	Applicant(s)/Patent Under Reexamination			
10574898	WATANABE ET AL.			
Examiner	Art Unit			
Wai-Sing Louie	2814			

SEARCHED					
Class	Subclass	Date	Examiner		
257	750,758,759,779,782	2/8/08	WSL		

SEARCH NOTES		
Search Notes	Date	Examiner
wiring board, insulating resin, thermosetting, flip chip, bumps, sharp tip	2/8/08	WSL
solder bump, sharp tip, conical shape	8/15/08	WSL

INTERFERENCE SEARCH			
Class	Subclass	Date	Examiner

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